

PWM or Singl-Wire Dimming, 4-Channels WLED Linear Driver

DESCRIPTION

The BL8581A is a CMOS based White/Blue LED driver with stand-alone capability. The driver is primarily designed for LED backlighting of LCD display powered by Li-ion battery. With its high efficiency, low standby current and wide range of input supply voltage, the BL8581A is suitable for applications such as portable device display and keypad backlighting. It can realize PWM or single-wire dimming control through EN pin.

BL8581A has four LED channels with MSOP-8 or QFN 3X3 -16 package.

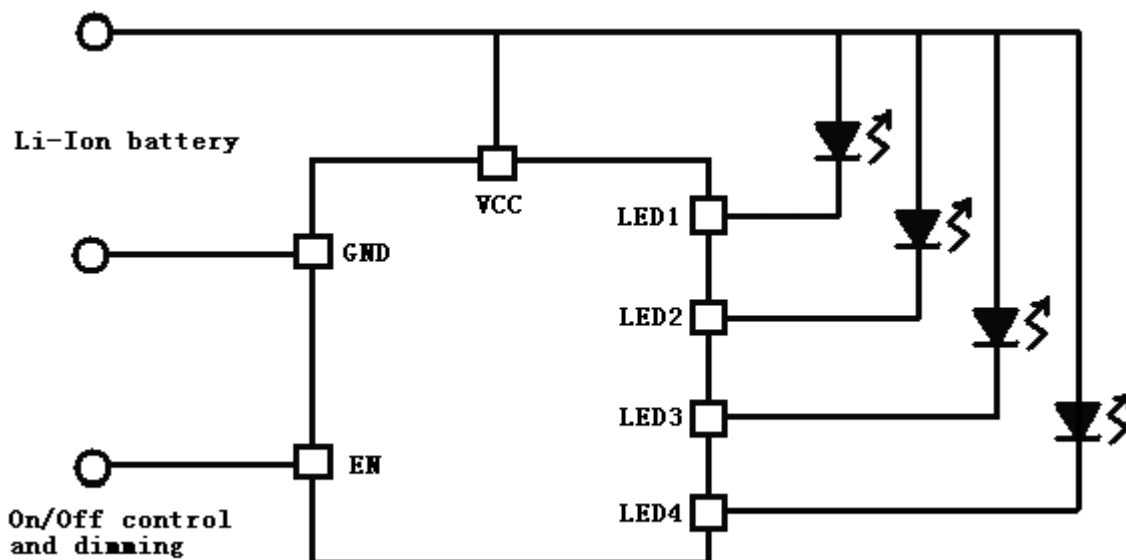
FEATURES

- 2.7 to 5.5V input range
- Single-wire dimming control with linear 16- steps
- PWM dimming control
- LED sink current of max. 20mA
- Independent current sink circuit for each LED output
- Low standby current
- High accuracy current match on each channel

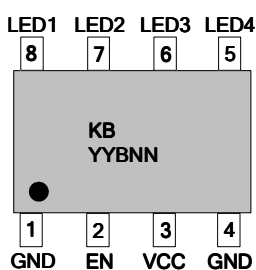
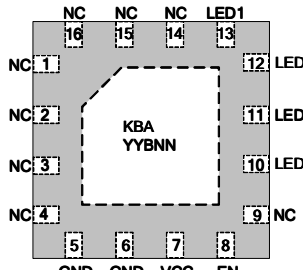
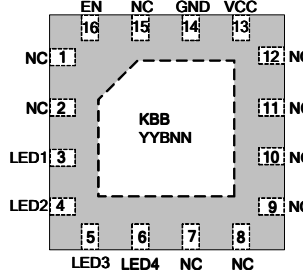
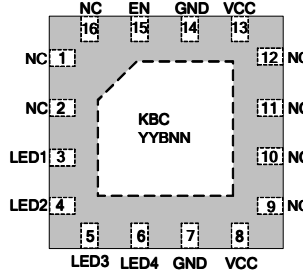
APPLICATIONS

- Small Size Color LCD Backlights Driver
- Mobile Phone, Portable Device Keypad Backlights Driver

TYPICAL APPLICATION



MARKING INFORMATION

Product Classification		BL8581ACE8TR
Marking		
KB YYBZZ	KB: Product Code YY: LOT No. B: FAB Code ZZ: Date Code	 Top view
Product Classification		BL8581ACJKATR
Marking		
KBA YYBZZ	KBA: Product Code YY: LOT No. B: FAB Code ZZ: Date Code	 Top view
Product Classification		BL8581ACJKBTR
Marking		
KBB YYBZZ	KBB: Product Code YY: LOT No. B: FAB Code ZZ: Date Code	 Top view
Product Classification		BL8581ACJKCTR
Marking		
KBC YYBZZ	KBC: Product Code YY: LOT No. B: FAB Code ZZ: Date Code	 Top view

ORDERING INFORMATION

BL8581A 1 2 3

Code	Description
1	Temperature&RoHS: C: -40~85°C, Pb Free RoHS Std.
2	Package type: E8: MSOP-8 JKA: QFN 3X3 -16 JKB: QFN 3X3 -16 JKC: QFN 3X3 -16
3	Packing type: TR:Tape&Reel (Standard)

PIN DESCRIPTION

Name	Function Description
LED1-LED4	RGB or WLED Cathode Connection Pin
EN	Chip Enable and Dimming Control
VCC	Power Supply
GND	Ground
NC	Not Connected

ABSOLUTE MAXIMUM RATING

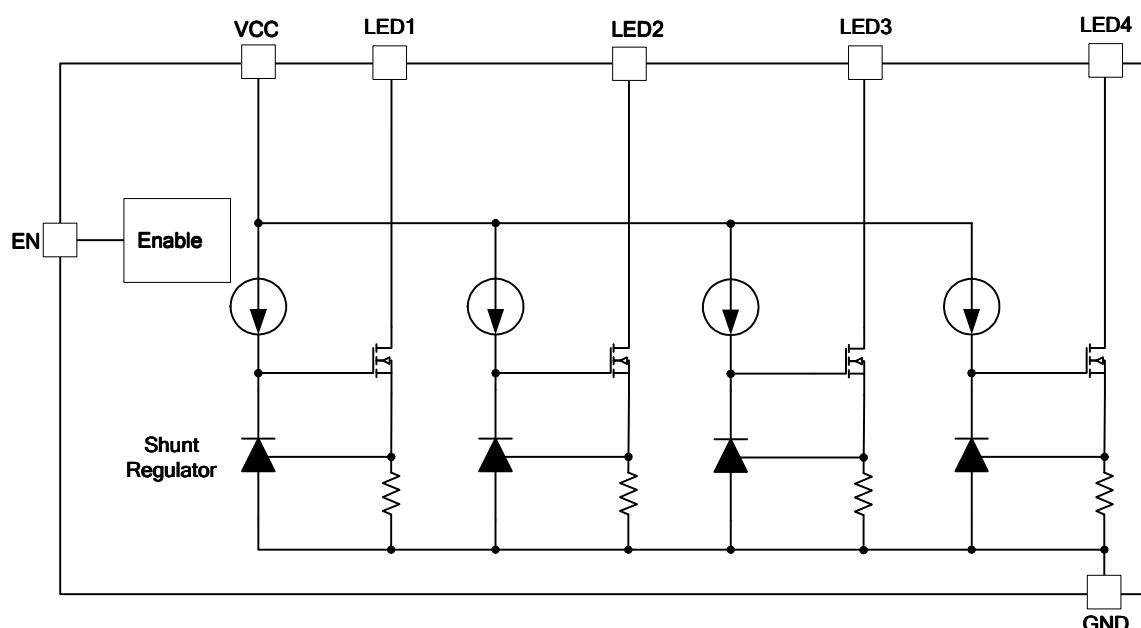
Supply voltage	-0.3V to 7V
Voltage of LEDn, EN pin	-0.3V to 7V
Maximum Junction Temperature	125°C
Operating Ambient Temperature Range	-40°C to 85°C
Storage Temperature Range	-40°C to 150°C
Lead Temperature (Soldering, 10 sec)	260°C

Note: Exceed these limits to damage to the device.
Note: Exposure to absolute maximum rating conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Items	MIN	MAX	Unit
Supply Voltage Range	2.7	5.5	V
Operating Temperature	-25	85	°C

BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

VCC=3.7V, T _a =25°C, No Load, Input: VEN=3.7V. (Unless otherwise noted)						
Symbols	Parameters	Conditions	MIN	TYP	MAX	Unit
V _{IL}	EN Pin "Low" Logic				0.4	V
V _{IH}	EN Pin "High" Logic		1.7			V
I _{IL}	EN Pin "Low" Input Current		-1			μA
I _{IH}	EN Pin "High" Input Current				1	μA
T _d	PWM dimming control delay time			20		μS
T _{lat}	Latch off time before transient to the new current level (see figure 2)			20		μS
T _{pulse}	Required positive and negative pulse width	Pulse dimming control	4		20	μS
V _{LEDL}	LEDn Dropout Voltage			100		mV
I _{LED}	LEDn Sink Current		18	20	22	mA
ΔI _{LEDn}	LEDn Sink Current Deviation		-3		3	%
I _Q	Quiescent Current			250	400	μA
I _{STBY}	Standby Supply Current	VEN="0"		0.5		μA

DETAILED DESCRIPTION

BL8581A works with a wide range of supply voltage, from 2.7V to 5.5V. The forward voltage of commercial white/blue LED is in the range of 2.9V to 3.5V at a current level of 20mA. Proper selection of the LED to match the supply voltage can fully utilize the Li-ion battery. For example, there is 1% ~ 3 % power left in the Li-ion battery when its voltage reaches 3.275V. So a LED with a forward voltage value of 3.2V can use up to 99% of the battery power under normal working condition. When the voltage of the battery drops below 3.2V, the current through the LED (hence the brightness) starts to decrease.

Startup sequence

BL8581A starts to work only when VCC powered on and the EN pin became high after a delay, the delay time is at least 4us. EN pin is not allowed to connect to VCC directly or keep it floating.

PWM dimming control

If the frequency of the PWM signal to the EN pin is less than 5KHz, the average LED current is proportional to the duty cycle of the PWM signal, and the EN works as a simple on/off control. A high level turns on and a low shuts down the LEDs. There is a delay time between the input PWM signal and the output LED current waveform, as shown in Fig.1, the T_D is about 20uS.

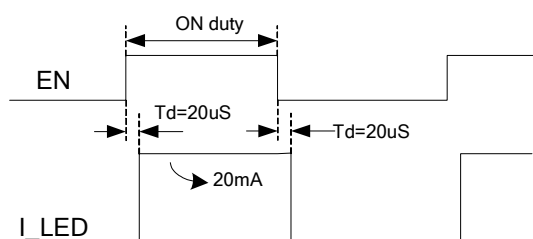


Fig. 1 PWM Dimming Control

Single-wire dimming control

The LEDs' brightness can also be controlled by the pulses applied to the EN pin. Refer to the Fig. 2. Inside the device there is a 4-bit counter connecting to the EN pin. The LED current can be programmed up to 16 levels depends on the number of rise edges of the input waveform. A high level input ("1") with

pulse width wider than 20uS is regarded as a signal to stop the build-in counter. The time between two wide high levels (more than 20uS) is a counting period. When some rise edges occur between two high level pulses of 20us, the equation as shown below can calculate the active pulse number, called Code_No.

$$\text{Code_No} = \text{Mod}(N, 16),$$

In the equation, N is the number of rise edges of the input waveform and mod function returns the remainder of N divided by 16. For example, if N=0, 16, or other integral multiple of 16, the mod function returns a value of 0, if N=1, 17 or other integral multiple of 16 plus 1, the mod function returns a value of 1, and so on.

The relationship between LEDs' brightness and the Code_No is listed as the following table.

Code No	I _{SET} /20mA	Code No	I _{SET} /20mA
0	0	8	8/15
1	15/15	9	7/15
2	14/15	10	6/15
3	13/15	11	5/15
4	12/15	12	4/15
5	11/15	13	3/15
6	10/15	14	2/15
7	9/15	15	1/15

The frequency of the input pulse should be lower than 100KHz, and the width of the high level and low level larger than 4uS to prevent false trigger.

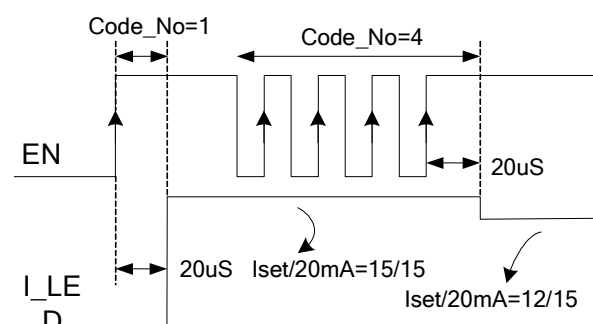
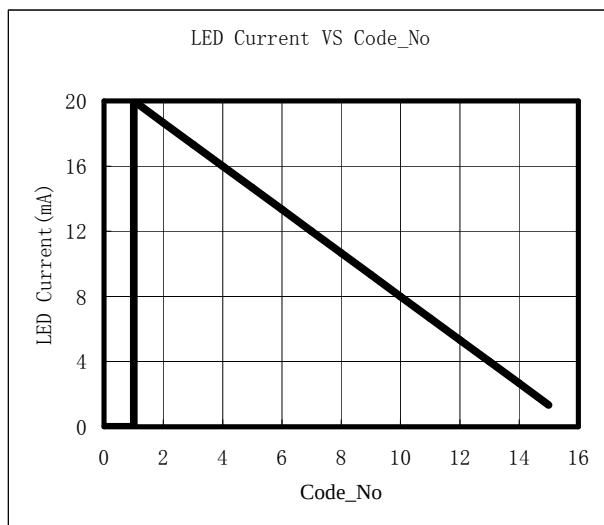
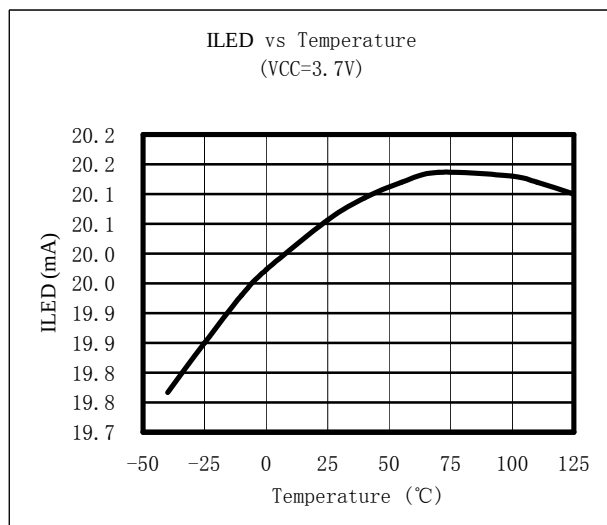
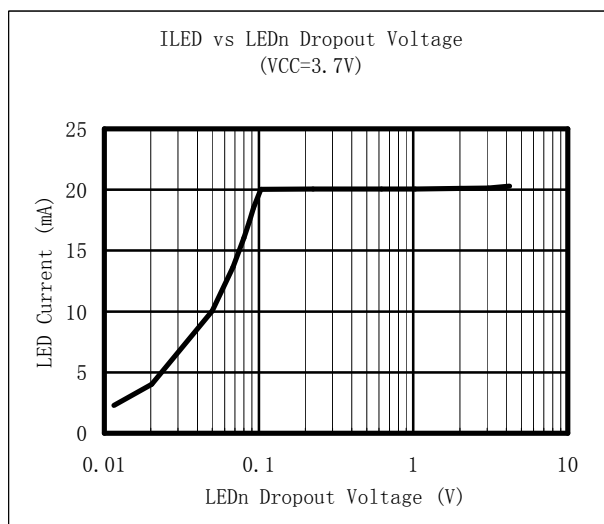
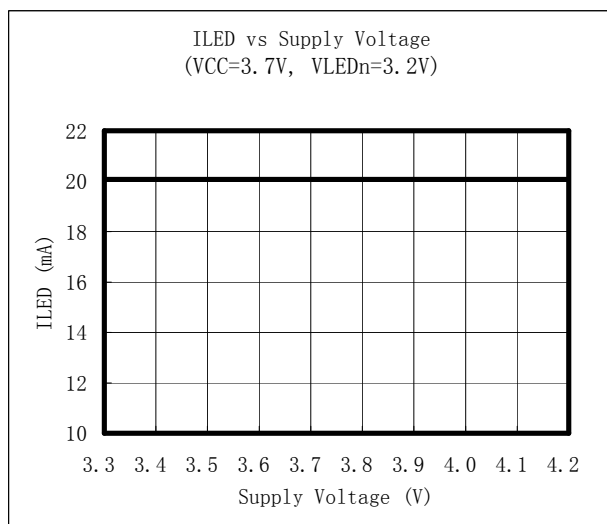
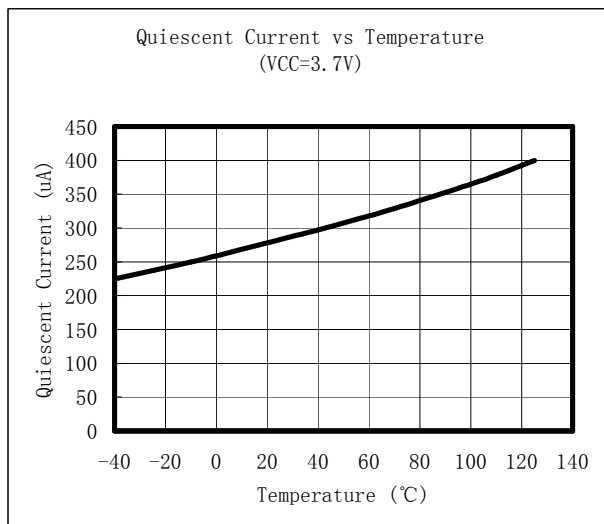
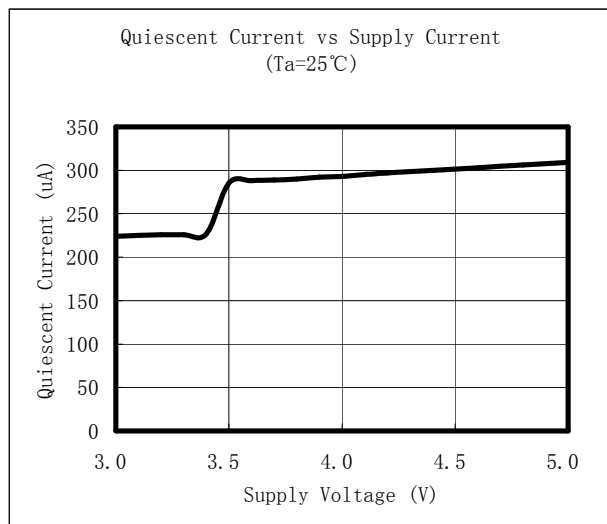


Fig. 2 Single-Wire Dimming Control

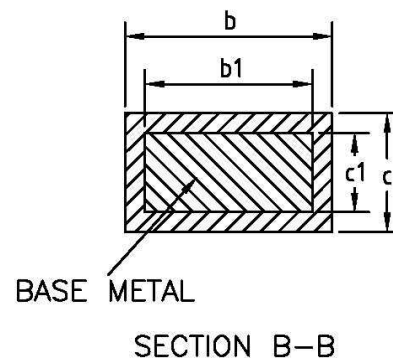
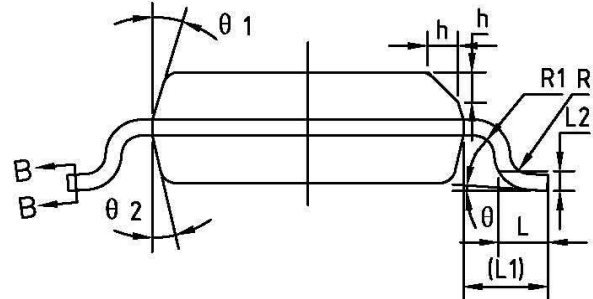
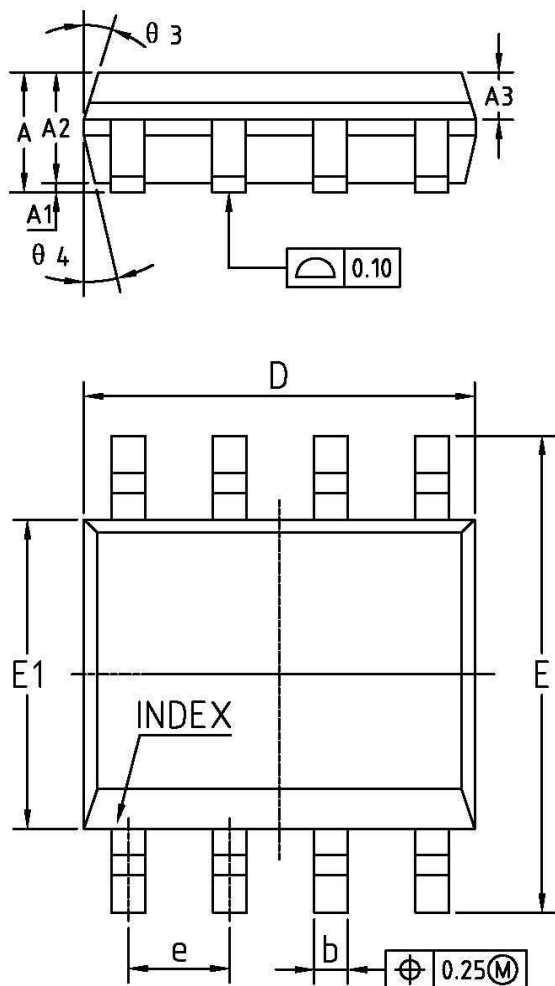
TYPICAL PERFORMANEN CHARACTERISTICS



PACKAGE INFORMATION

Package	MSOP-8	Devices per reel	3000Pcs	Unit	mm
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Package specification:



Symbol	Dimension (mm)			Symbol	Dimension (mm)		
	MIN	NOM	MAX		MIN	NOM	MAX
A	-	-	1.10	D	2.90	3.00	3.10
A1	0.05		0.15	E	4.70	4.90	5.10
A2	0.75	0.85	0.95	E1	2.90	3.00	3.10
A3	0.30	0.35	0.40	e	0.65BSC		
b	0.29	-	0.38	L	0.40	-	0.70
b1	0.28	0.30	0.33	L1	0.95BSC		
c	0.15	-	0.20	θ	0	-	8°
c1	0.14	0.152	0.16				

PACKAGE INFORMATION

Package	QFN3X3-16	Devices per reel	3000	Unit	mm
The mechanical drawing illustrates the QFN3X3-16 package in three views: Top View: Shows a square package with a central cross. The width is dimensioned as 2.900(0.114) mm and 3.100(0.122) mm. The height is dimensioned as 2.900(0.114) mm and 3.100(0.122) mm. A 'Pin 1 Identification' dot is located in the top right corner. Bottom View: Shows the underside of the package with 16 pins. The central 'Exposed Pad' is dimensioned as 1.500(0.059) mm wide and 1.500(0.059) mm high. The distance from the pin 1 identification corner to the center of the exposed pad is 0.180(0.007) mm. The distance from the center of the exposed pad to the center of a pin is 0.280(0.011) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 0.450(0.018) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 0.550(0.022) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 0.350(0.014) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 0.450(0.018) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 1.500(0.059) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 1.500(0.059) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 1.500(0.059) mm. The distance from the center of the exposed pad to the center of a pin on the opposite side is 1.500(0.059) mm. Side View: Shows the profile of the package. The total height is dimensioned as 0.700(0.028) mm and 0.900(0.035) mm. The distance from the base of the package to the top of the exposed pad is dimensioned as 0.178(0.007) mm and 0.228(0.009) mm. The distance from the base of the package to the top of the exposed pad is dimensioned as 0.000(0.000) mm and 0.050(0.002) mm.					